











PRODUCT DATASHEET



- ► PLCC2 SMD
- ➤ 3528 1.9t Series
- ► Cool White (6000K)

N0W09S72





3528 1.9t Series





FEATURES:

- Package: Top View PLCC2 White SMD Package
- Forward Current: 20mA
- Forward Voltage (typ.): 3.2V
- Luminous Intensity (typ.): 2400mcd@20mA
- Colour: Cool White
- Colour Temperature (CCT): 6000K
- Viewing angle: 120°
- **Materials:**
 - Die: InGaN
 - Resin: Silicon (Yellow Diffused)
 - L/T Finish: Ag plated
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+100°C
- **Grouping parameters:**
 - Forward Voltage
 - **Luminous Intensity**
 - **CIE Chromaticity**
- Soldering methods: Reflow Soldering
- **Preconditioning:** MSL 2a according to J-STD020
- Packing: 8mm tape with max.2000/reel, ø180mm (7")

APPLICATIONS:

- Portable Lighting
- **Commercial Lighting**
- **Indoor Lighting**
- Backlight for LCD
- **General Lighting**



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	I _F	30	mA
Pulse Forward Current @Duty 1/10, 0.1ms	IPF	100	mA
Reverse Voltage	V _R	5	V
Reverse Current @10V	I _R	10	μΑ
Junction Temperature	Tj	110	°C
Electrostatic Discharge (HBM)	ESD	1000	V
Operating Temperature	T _{OPR}	-40~+85	°C
Storage Temperature	T _{STG}	-40~+100	°C
Soldering Temperature	T _{SOL}	260	°C
Colour Rendering Index	CRI	>70	

Electrical & Optical Characteristics (Ta=25°C)

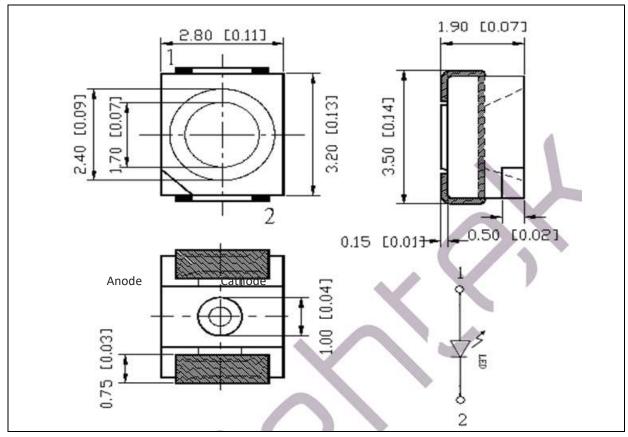
Parameter	Symbol	Values			Unit	Test	
Parameter	Зуппоп	Min.	Тур.	Max.	Offic	Condition	
Forward Voltage	VF	2.8	3.2	3.6	V	I _F =20mA	
Luminous Intensity	lv	2050	2400		mcd	I _F =20mA	
Chromaticity Coordinates	Х		0.3220			I _F =20mA	
	Υ		0.3350				
Colour Temperature	ССТ	5450	6000	6650	К	I _F =20mA	
Viewing Angle	2θ _{1/2}		120		deg	I _F =20mA	

^{1.} Luminous Intensity (Φ_V) $\pm 10\%$, Forward Voltage (V_F) $\pm 0.1V$, Colour Coordinate: ± 0.005 , Viewing Angle($2\theta 1/2$) $\pm 5\%$, CRI ± 5



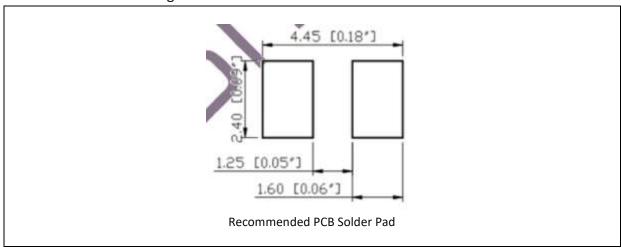
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 20mA):

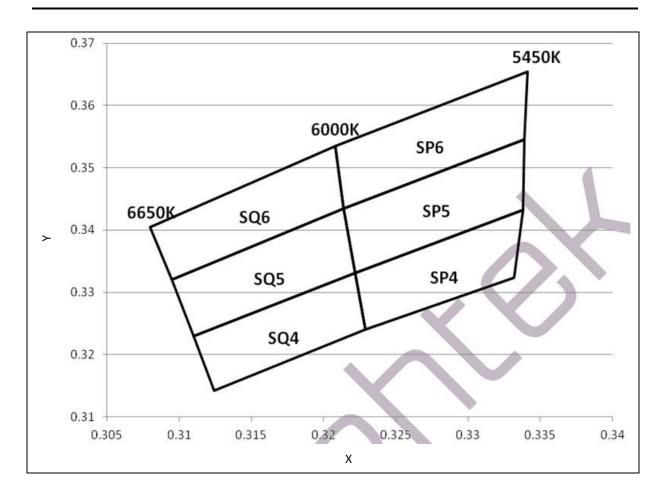
Code	Min.	Max.	Unit
В	2.8	2.9	
С	2.9	3.0	
D	3.0	3.1	
E	3.1	3.2	V
F	3.2	3.3	V
G	3.3	3.4	
Н	3.4	3.5	
I	3.5	3.6	

Luminous Intensity Classifications (I_F = 20mA):

Code	Min.	Max.	Unit
6	2050	2250	
7	2250	2450	mad
8	2450	2650	mcd
9	2650	2850	



CIE CHROMATICITY DIAGRAM:

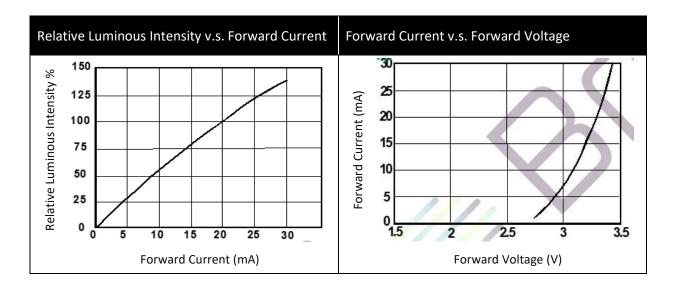


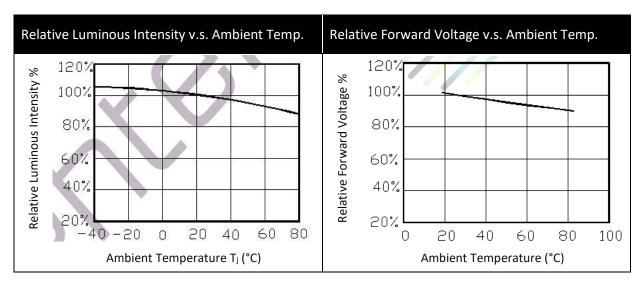
Chromaticity Coordinates Classifications (IF = 20mA):

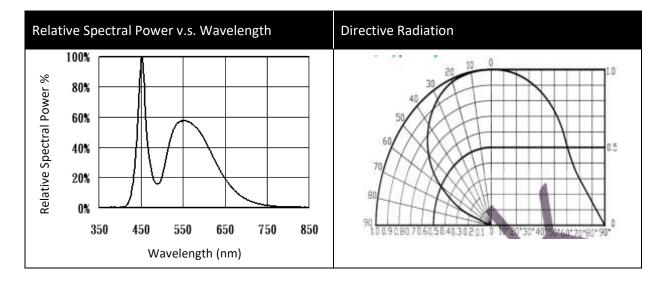
	-	1	2		3		4	
	Х	Υ	Х	Υ	Х	Υ	Х	Υ
SP6	0.3208	0.3535	0.3214	0.3434	0.3339	0.3545	0.3341	0.3654
SP5	0.3214	0.3434	0.3222	0.3331	0.3338	0.3432	0.3339	0.3545
SP4	0.3222	0.3331	0.3229	0.3240	0.3332	0.3323	0.3338	0.3432
SQ6	0.3080	0.3405	0.3095	0.3320	0.3214	0.3434	0.3208	0.3535
SQ5	0.3095	0.3320	0.3110	0.3230	0.3222	0.3331	0.3214	0.3434
SQ4	0.3110	0.3230	0.3124	0.3142	0.3229	0.3240	0.3222	0.3331



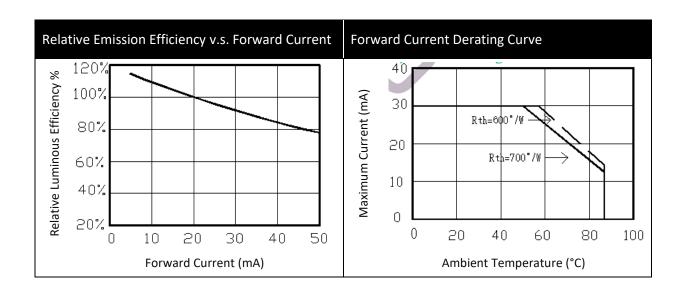
ELECTRO-OPTICAL CHARACTERISTICS:







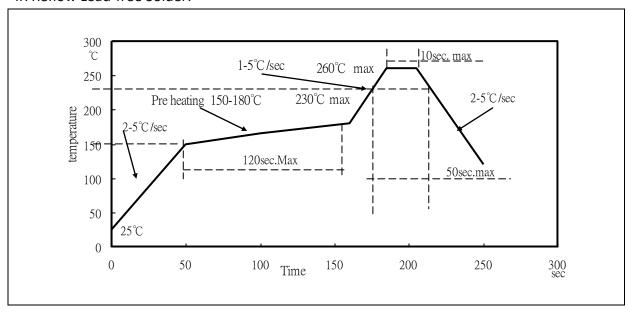






RECOMMENDED SOLDERING PROFILE:

IR Reflow Lead-free Solder:



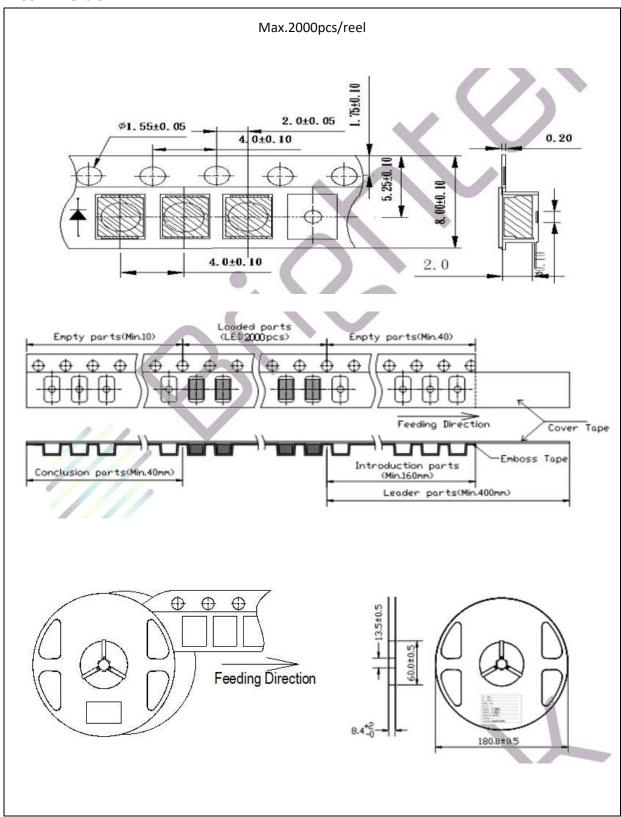
Note:

- 1. Recommended soldering temperature: 240°C. The maximum soldering temperature should be limited to 260°C.
- 2. Maxima reflow soldering: 3 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking.

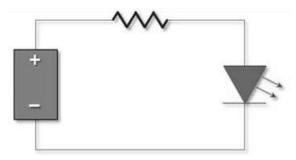
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 6hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	29/07/2016	Datasheet set-up.
A1.1	17/02/2022	Revise bin range.